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SH7145 Group

SCI Break Detection

Introduction

This application note discusses break detection during asynchronous communication using the SH7145F's SCI (Serial Communication Interface) module.

Target Device

SH7145F

Contents

1. Specifications	2
2. Description of Functions	3
3. Description of Operation	6
4. Description of Software	7
5. Flowchart.....	10
6. Program Listing	15

1. Specifications

As shown in figure 1, break detection is performed using channel 0 (ch0) of the SH7145F's SCI. Break detection is only possible in asynchronous communication. In the SH7145, break detection is not performed by hardware, and so is executed by software.

Break detection is performed by monitoring the level of the RxD pin when a framing error occurs: if the RxD pin is at low level, it is regarded that a break has occurred. In this sample task, break detection is performed after receiving three bytes of data. Confirmation of the RxD pin level at the time of a framing error is performed three times at 5 msec intervals, and a break is detected if the level is low all three times. When a break is detected, the RE bit of SCR_0 is cleared to 0 to terminate the reception by the SCI. The RxD pin state is checked using a compare-match timer interrupt.

The SCI communication format is 19,200 bps, 8 bits, one stop bit, and no parity.

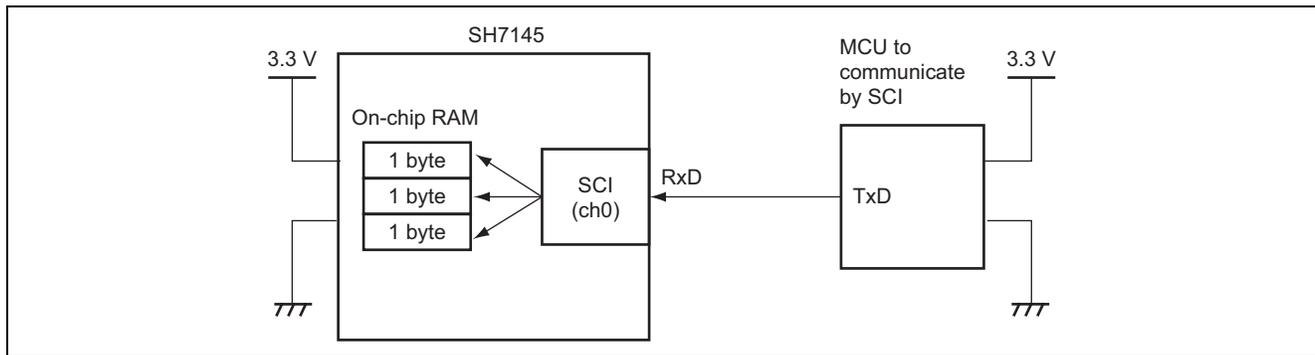


Figure 1 SH7145 SCI Reception Connection Diagram

Table 1 Asynchronous Serial Reception Format

Item	Setting
Bit rate	19200 bps
Data length	8 bits
Parity bit	none
Stop bit	1 bit
Serial/parallel conversion format	LSB first

2. Description of Functions

In this sample task, the SCI (Serial Communication Interface) and CMT (Compare-Match Timer) are used.

2.1 Serial Communication Interface (SCI)

In this sample task, the SCI is used to perform asynchronous serial data communication. Figure 2 is the block diagram of SCI module channel 0 (ch0); below, functions are explained referring to figure 2.

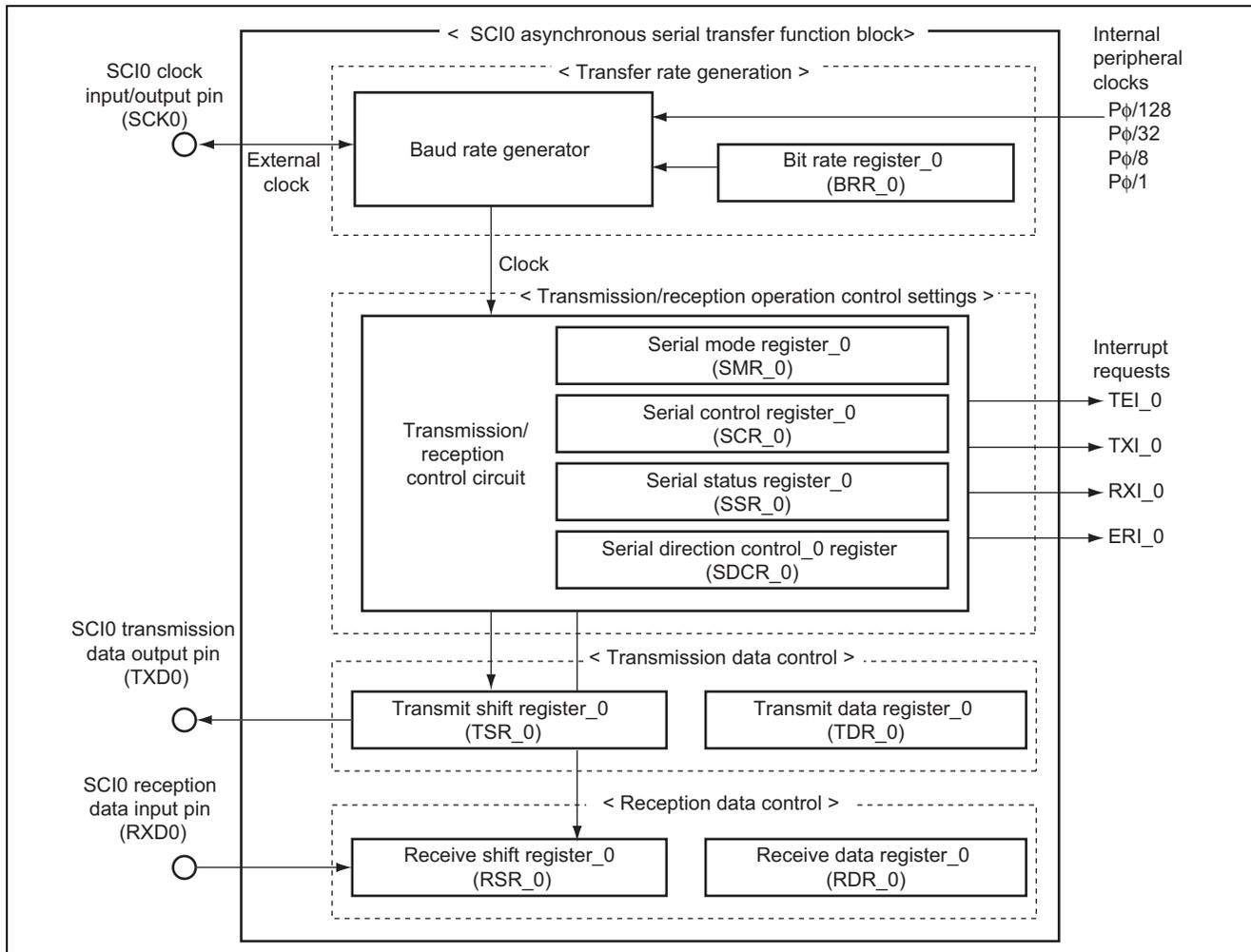


Figure 2 Block Diagram of SCI (ch0)

- In asynchronous mode, serial data communication is performed with synchronization in character units, allowing serial communication with a dedicated asynchronous communication LSI conforming to the Universal Asynchronous Receiver/Transmitter (UART), Asynchronous Communication Interface Adapter (ACIA) or other standard. Further, in asynchronous mode, a function (multiprocessor communication function) is provided for serial communications with multiple processors.
- The internal peripheral clock P ϕ is a reference clock used to drive the on-chip peripheral functions, and is generated by the clock pulse generator.
- The receive shift register (RSR_0) is a register used to receive serial data. Serial data is input from the RxD0 pin, and when data for one frame has been received, the data in RSR_0 is automatically transferred to the receive data register (RDR_0). RSR_0 cannot be accessed from the CPU.
- The receive data register (RDR_0) is an 8-bit register used to store received data. Upon receiving data for one frame, the data is automatically transferred from RSR_0. RSR_0 and RDR_0 have a double-buffered structure, so that continuous receive operation is possible. Since RDR_0 is a receive-only register, only reading is possible from the CPU.
- The transmit shift register (TSR_0) is a register used to transmit serial data. During transmission, data is transmitted from the transmit data register (TDR_0) to TSR_0, and the transmission data is output from the TxD0 pin. TSR_0 cannot be directly accessed from the CPU.
- The transmit data register (TDR_0) is an 8-bit register used to store data for transmission. When TSR_0 is detected to be empty, data written to TDR_0 is automatically transferred to TSR_0. TDR_0 and TSR_0 have a double-buffered structure, so that when data for one frame has been transmitted and the next data is written to TDR_0, the data is transferred to TSR_0. Continuous transmission is thus possible. TDR can always be read and written by the CPU, but writing should be performed after confirming that the TDRE bit of the serial status register (SSR_0) is 1.
- The serial mode register (SMR_0) is an 8-bit register used to select the serial data communication format and the clock source for the internal baud rate generator.
- The serial control register (SCR_0) is a register used to control transmission/reception and interrupts and select the transmission/reception clock source.
- The serial status register (SSR_0) consists of SCI0 status flags and transmission/reception multiprocessor bits. TDRE, RDRF, ORER, PER, and FER can only be cleared.
- The serial direction control register (SDCR_0) is used to select LSB-first or MSB-first. In 8-bit length communications, either LSB-first or MSB-first can be selected, but in 7-bit communications, LSB-first should be selected.
- The bit rate register (BRR_0) is an 8-bit register used to adjust the bit rate. In the SCI, a baud rate generator is provided independently for each channel, so that different bit rates can be set. For the relationship between the setting values and the execution rate and other details, please refer to the hardware manual.

Table 2 shows the assignment of functions in this sample task.

Table 2 Assignment of Functions

Element	Classification	Description
TXD0	Pin	Channel 0 transmission data output pin
RXD0	Pin	Channel 0 reception data input pin
SMR_0	SCI0	Sets communication format to asynchronous mode.
SCR_0	SCI0	Enables reception.
SSR_0	SCI0	Status flags indicating the operation state of SCI0
SDCR_0	SCI0	Set to select LSB-first.
BRR_0	SCI0	Sets the communication bit rate.
TSR_0	SCI0	Register for serial data transmission
TDR_0	SCI0	Register for storing data for transmission
RSR_0	SCI0	Register for receiving serial data
RDR_0	SCI0	Register for storing received data

2.2 Compare-Match Timer (CMT)

The CMT generates an interrupt at given intervals. Figure 3 is a block diagram of the CMT module channel 0 (ch0); below, functions are explained referring to figure 3.

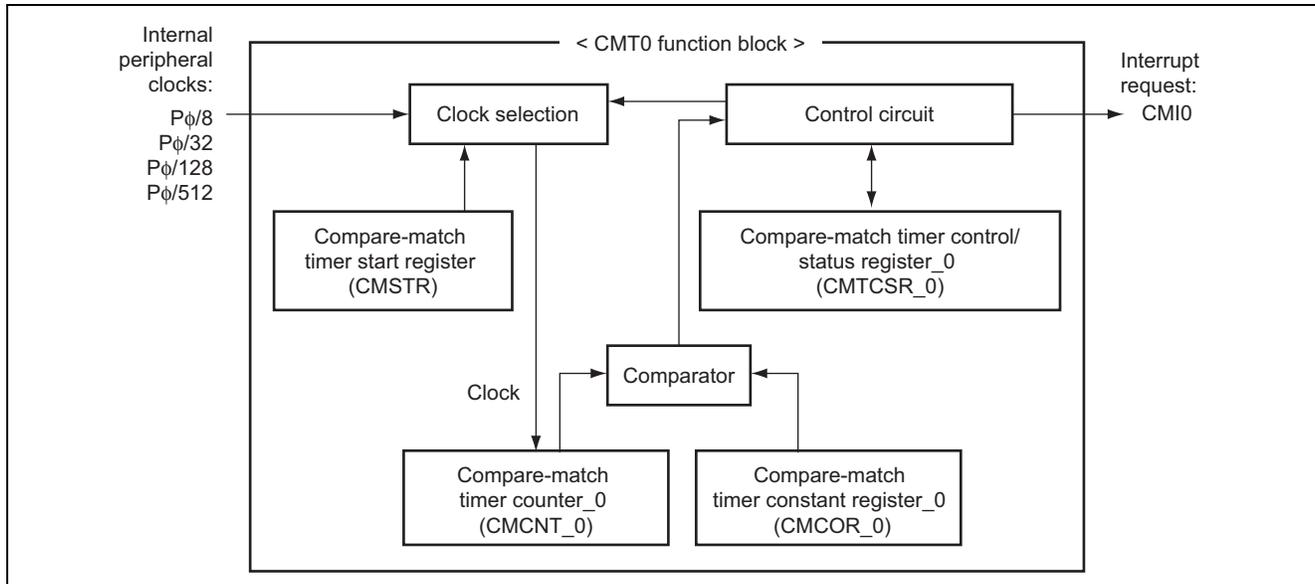


Figure 3 CMT (ch0) Block Diagram

- The CMT has a 16-bit counter, and can generate an interrupt at given intervals.
- A clock signal obtained by dividing the internal peripheral clock $P\phi$ can be selected. The counter is incremented by the selected clock.
- The compare-match timer start register (CMSTR) starts or stops counting.
- The compare-match timer control/status register (CMCSR_0) indicates compare-match occurrence, sets up interrupts, and selects the count-up clock.
- The compare-match timer counter (CMCNT_0) is an up-counter used to generate interrupt requests.
- The compare-match timer constant register (CMCOR_0) sets the compare-match interval.

3. Description of Operation

Figure 4 shows the operation during reception in asynchronous mode in this sample task. As an explanation of figure 4, table 3 describes the software and hardware processing.

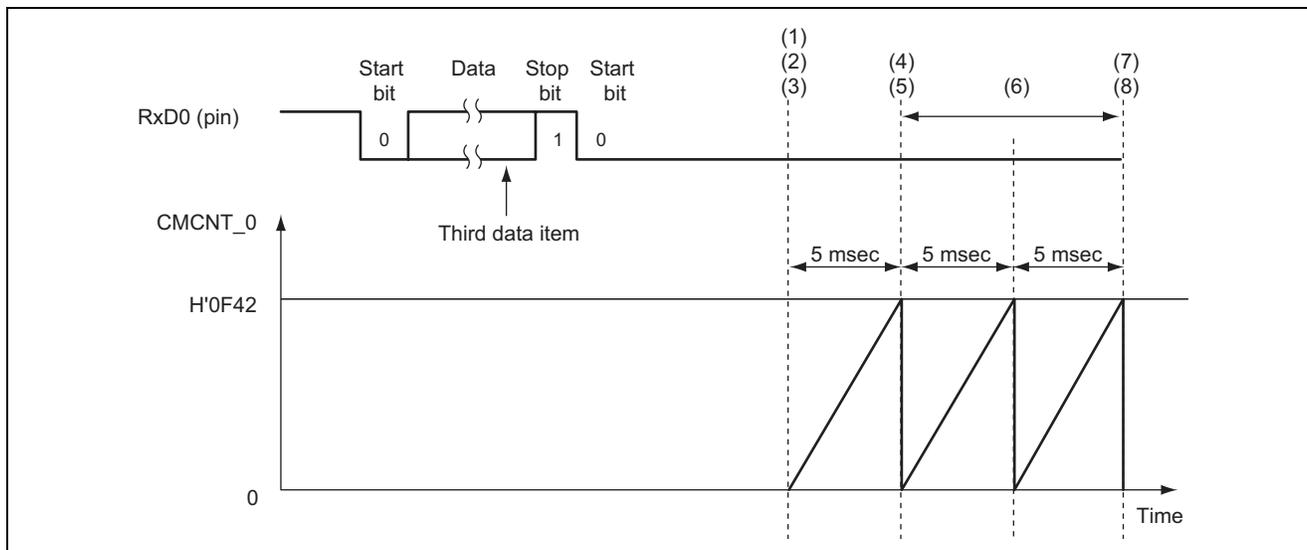


Figure 4 Operation during Data Reception

Table 3 Description of Processing

Software Processing	Hardware Processing
(1) Framing error processing	Set the FER bit in SSR_0 to 1.
(2) Set the STR0 bit in CMSTR to 1.	Start counting by CMT0.
(3) —	Set the CMF flag (generate a compare-match interrupt).
(4) Clear the CMF flag to 0.	Start counting by CMT0.
(5) Read RxD pin level.	—
(6) Repeat steps (3) through (5) twice.	Repeat steps (3) through (5) twice.
(7) Clear the STR0 bit in CMSTR to 0.	Stop operation of CMT0.
(8) Clear the RE bit in SCR0 to 0.	Stop reception by SCI0.

4. Description of Software

4.1 Modules

Table 4 describes the modules of this sample task.

Table 4 Description of Modules

Module Name	Label Name	Functions
Main routine	main	Calls various modules.
SCI routine	init_sci	Initializes SCI0 and CMT0.
Receive routine	rcv_sci	Receives serial data.
Error processing routine	err_int	Performs reception error processing.
CMT0 interrupt routine	cmt_int	Reads RxD pin level at 5 msec intervals.

4.2 Internal Registers

Tables 5 through 7 describe the internal registers used in this sample task. The settings are the values used in this sample task and are different from their initial values.

Table 5 Description of Internal Registers (1)

Register Name	Bit	Bit Name	Setting	Function
MSTCR1				Module standby control register 1
	0	MSTP16	0	SCI0 standby control bit When MSTP16 = 0, cancels the standby state.
MSTCR2				Module standby control register 2
	12	MSTP12	0	CMT standby control bit When MSTP12 = 0, cancels the standby state of the CMT.
SCR_0			H'10	Serial control register_0 Controls transmission/reception and interrupts and selects transmit/receive clock source.
	7	TIE	0	Transmit interrupt enable Set to 1 to enable TXI interrupt requests.
	6	RIE	0	Receive interrupt enable Set to 1 to enable RXI and ERI interrupt requests.
	5	TE	0	Transmit enable Set to 1 to enable transmission.
	4	RE	1	Receive enable Set to 1 to enable reception.
	3	MPIE	0	Multiprocessor interrupt enable (valid in asynchronous mode when MP = 1 in SMR) In this sample task, this bit is invalid because of MP = 0.
	2	TEIE	0	Transmit end interrupt enable Set to 1 to enable TEI interrupt requests.
	1	CKE1	0	Clock enable 1, 0
	0	CKE0	0	These bits select the clock source and SCK pin function. In this sample task, the clock source is an internal clock and the SCK pin is not used.

Table 6 Description of Internal Registers (2)

Register Name	Bit	Bit Name	Setting	Function
SMR_0			H'00	Serial mode register_0 Selects communication format and clock source for the internal baud rate generator.
	7	C/ \bar{A}	0	Communication mode When C/ \bar{A} = 0, SCI0 operates in asynchronous mode.
	6	CHR	0	Character length (only valid in asynchronous mode) When CHR = 0, communication data length is 8 bits.
	5	PE	0	Parity enable (only valid in asynchronous mode) When PE = 0, communication is performed with no parity.
	4	O/ \bar{E}	0	Parity mode (valid when PE = 1 in asynchronous mode) In this sample task, PE = 0 and so this bit is invalid.
	3	STOP	0	Stop bit length (only valid in asynchronous mode) When STOP = 0, one stop bit is used.
	2	MP	0	Multiprocessor mode (only valid in asynchronous mode) When MP = 0, multiprocessor communication function is disabled.
	1	CKS1	0	Clock select 1, 0
	0	CKS0	0	When CKS1 = CKS0 = 0, the clock source for the internal baud rate generator is set to P ϕ .
BRR_0			H'40	Bit rate register_0 An 8-bit register used to adjust the bit rate.
SDCR_0			H'F2	Serial direction control register_0 The DIR bit (bit 3) is used to select LSB/MSB-first; in this sample task, set to DIR = 0 (LSB-first).
SSR_0			H'xx	Serial status register_0 Consists of SCI0 status flags and communication multiprocessor bits; only 0 can be written to the status flags for flag clearing.
	7	TDRE	*	Transmit data register empty (status flag)
	6	RDRF	*	Receive data register full (status flag)
	5	ORER	*	Overrun error (status flag)
	4	FER	*	Framing error (status flag)
	3	PER	*	Parity error (status flag)
	2	TEND	*	Transmit end (status flag)
	1	MPB	0	Multiprocessor bit
	0	MPBT	0	Multiprocessor bit transfer
PACRL2				Port A control register L2
	0	PA0MD	1	PA0 mode bit Specifies the function of PA0, a multiplexed pin of Port A (Rx/D0).

Note: * Only clearing is possible; setting to 1 is done by hardware.

Table 7 Description of Internal Registers (3)

Register Name	Bit	Bit Name	Setting	Function
MSTCR2				Module standby control register 2
	12	MSTP12	0	CMT standby control bit When MSTP12 = 0, cancels the standby state of the CMT.
CMSTR			H'01	Compare-match timer start register
	15 to 2	—	0	Reserved
	1	STR1	0	Count start 1 When STR1 = 0, the CMCNT_1 stops counting.
	0	STR0	1	Count start 0 When STR0 = 1, the CMCNT_0 starts counting.
CMCSR_0				Compare-match timer control/status register_0
	15 to 8	—	0	Reserved
	7	CMF	*	Compare-match flag When CMF=1, CMCNT and CMCOR values match.
	6	CMIE	1	Compare-match interrupt enable Enables or disables compare-match interrupts. When CMIE=1, compare-match interrupts are enabled.
	5 to 2	—	0	Reserved
	1	CKS1	0	CMCNT_0 input clock select 1, 0
	0	CKS0	1	In this sample task, Pφ/32 is selected.
CMCNT_0			—	Compare-match timer counter_0 Up-counter used to generate interrupt requests.
CMCOR_0			H'0F42	Compare-match timer constant register_0 Specify the interval of compare-match with CMCNT_0.
IPRG			H'00F0	Interrupt priority register G Sets priority levels for interrupt sources.
	7 to 4	IPR7	1	These bits set the priority level of CMT0 (0-15).
		IPR6	1	
		IPR5	1	
		IPR4	1	

Note: * Only clearing is possible; setting to 1 is done by hardware.

4.3 Description of Arguments

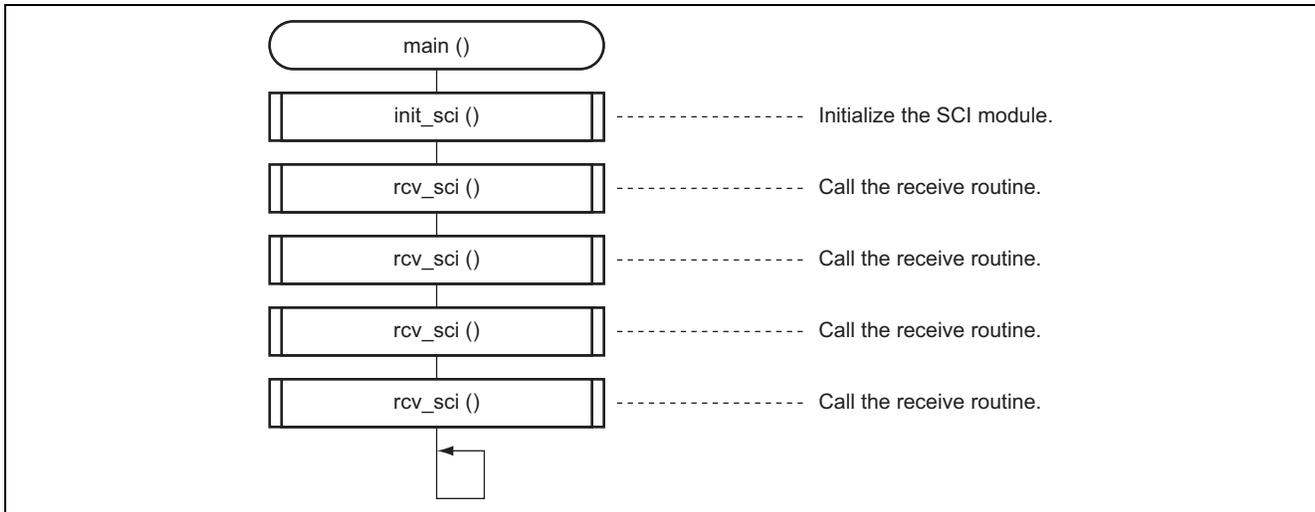
Arguments used in this sample task are described in table 8.

Table 8 Description of Arguments

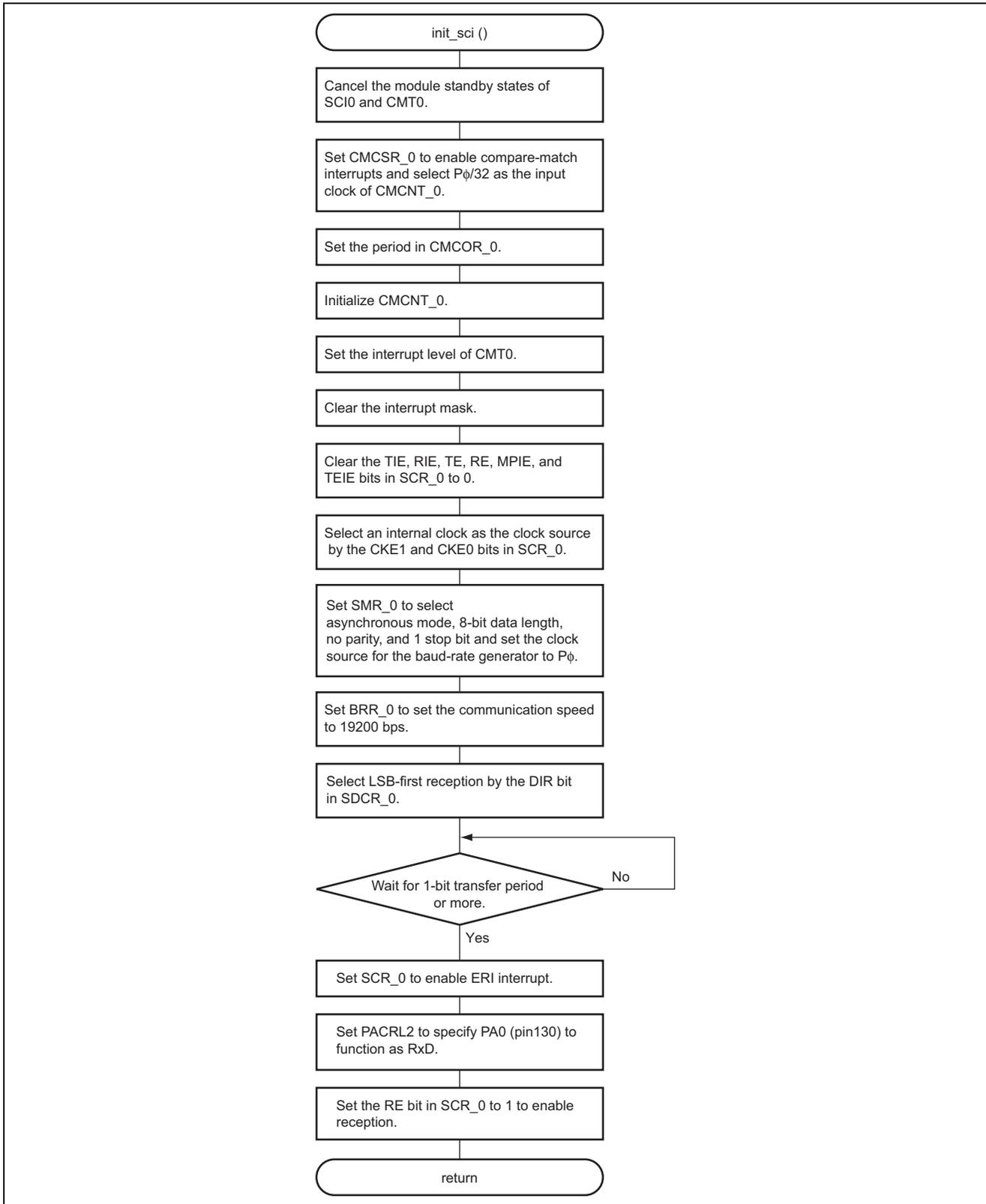
Argument Name	Function	Used in
Rev_data[0 to 2]	Stores data received by SCI0	Receive routine
T_count	Counts the number of CMT0 interrupts	CMT0 interrupt routine, error processing routine
Rd_count	Number of times level is low when RxD pin level is read	CMT0 interrupt routine, error processing routine

5. Flowchart

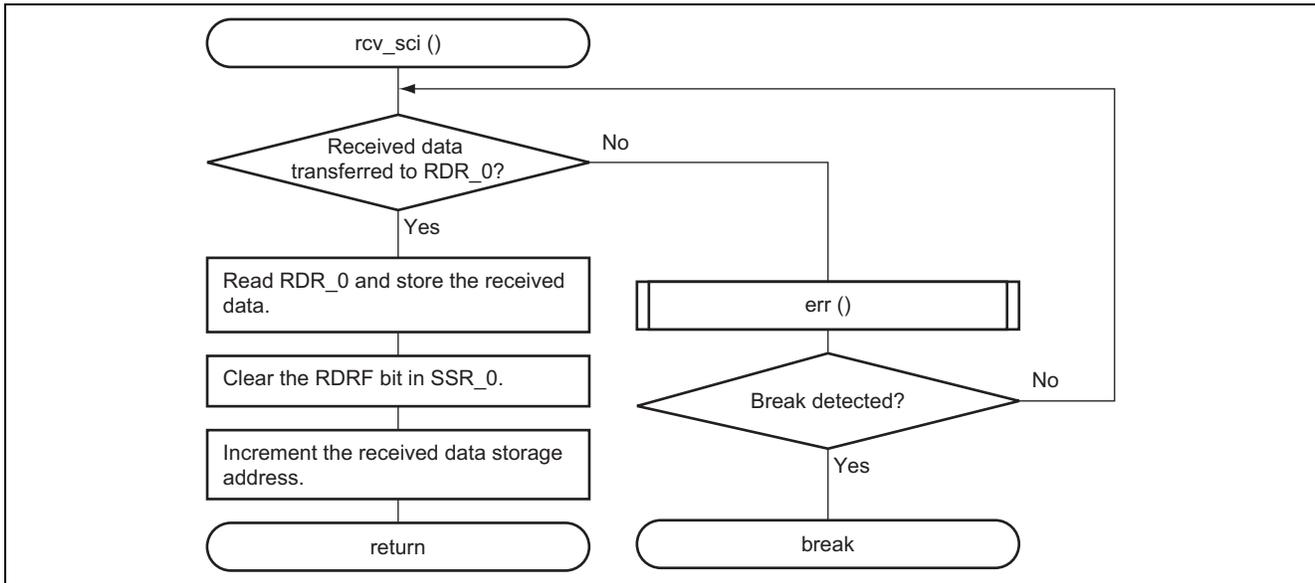
5.1 Main Routine



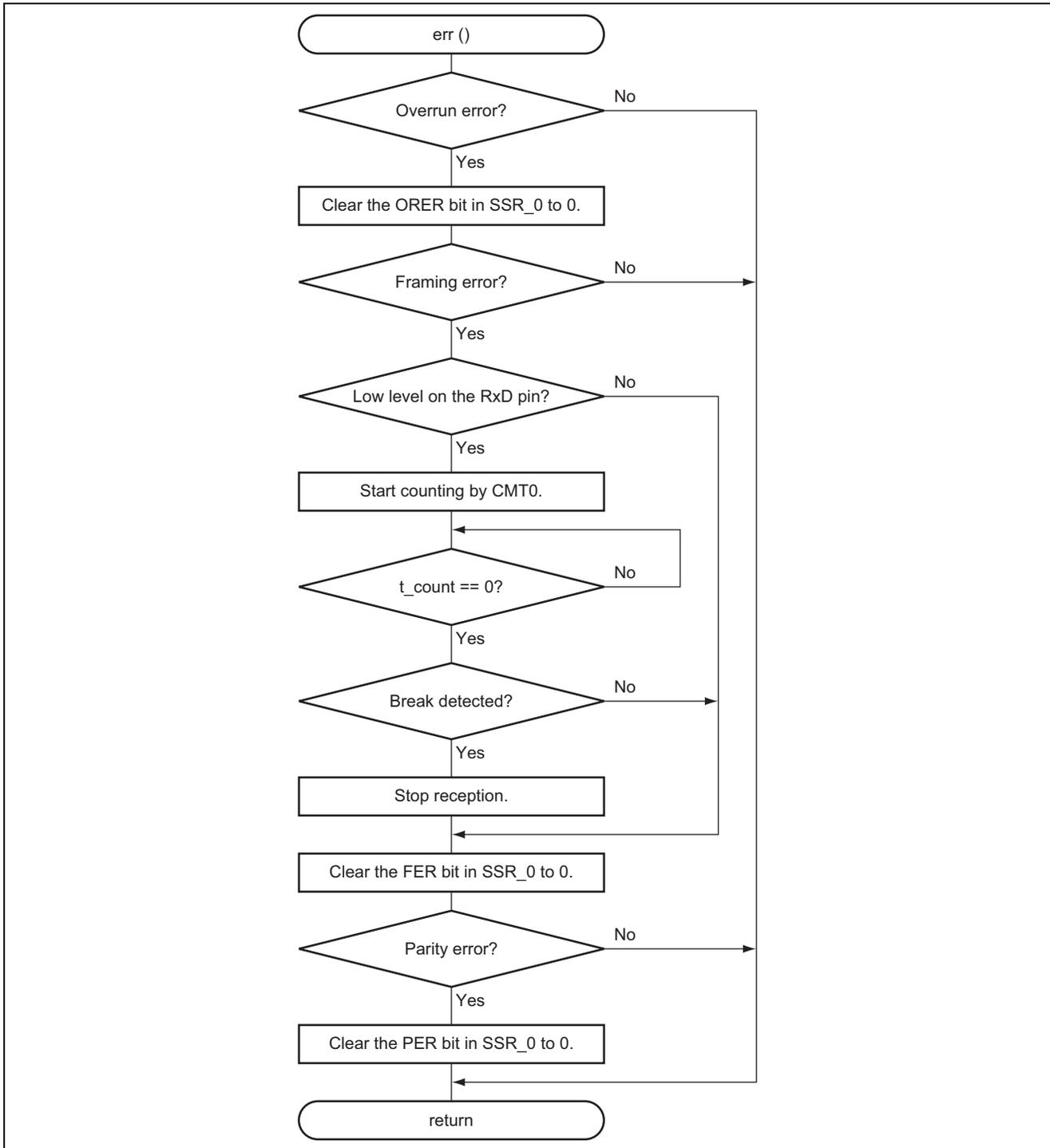
5.2 SCI Routine



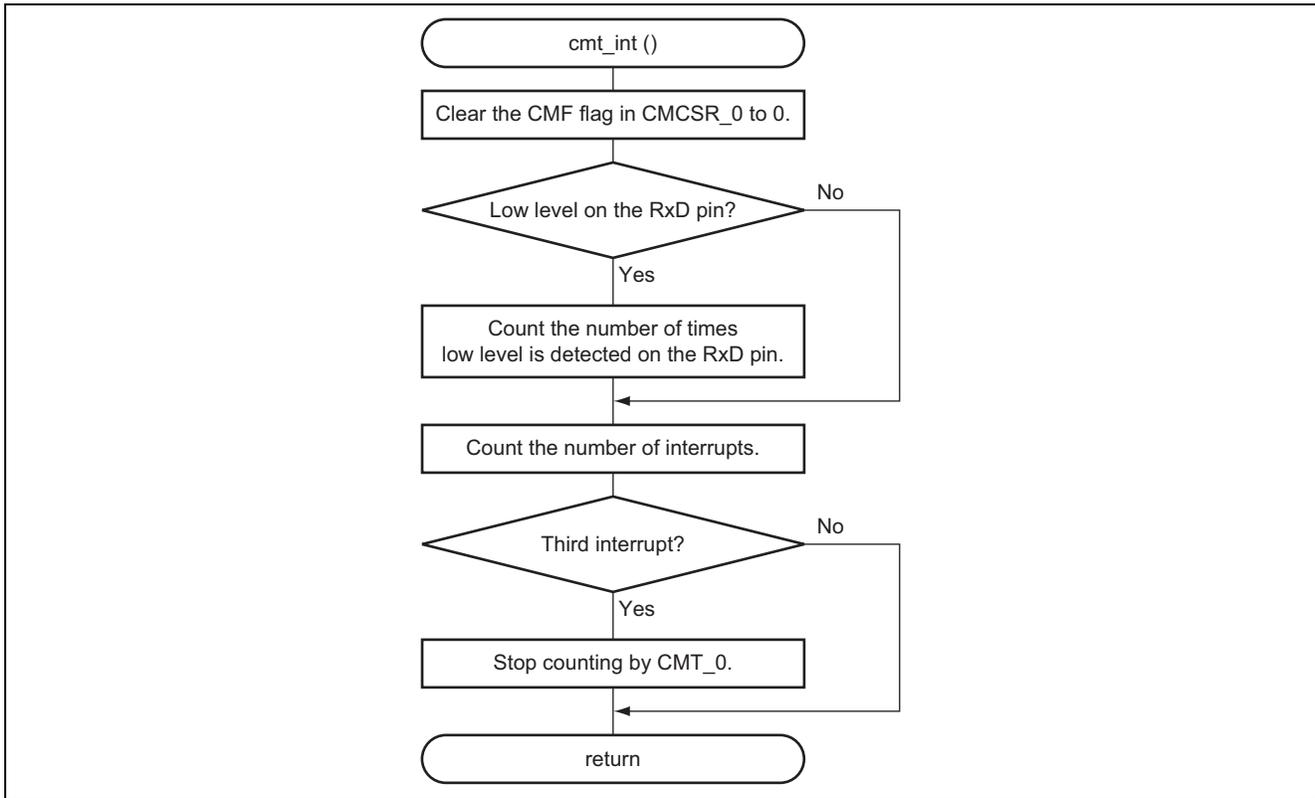
5.3 Receive Routine



5.4 Error Processing Routine



5.5 CMT0 Interrupt Routine



6. Program Listing

```

/*****
/* SH7145F   Application Note
/*
/* Function
/*   :SCI0
/*   :Asynchronous Receive Mode(break)
/*
/* External input clock      :12.5MHz
/* Internal CPU clock        :50MHz
/* Internal peripheral clock  :25MHz
/*
/* Written      :2003/12   Rev.1.0
/*****

#include "iodefine.h"
#include <machine.h>

/*****
/* Symbol Definition
/*****
#define COUNT 3

/*****
/* Function Define
/*****
void main(void);

void init_sci(void);
unsigned char rcv_sci(unsigned char);

void err(void);
void cmt_int(void);
void dummy_f(void);

/*****
/* RAM Allocation Definition
/*****
unsigned char T_count;          /* Timer interrupt count
unsigned char Rd_Count;        /* RxD low level count

volatile unsigned char Rev_data[COUNT]; /* Receive data

```

```

/*****
/* Main Program
/*****
void main( void )
{
    unsigned char i = 0;

    init_sci();                /* SCI initialize routine          */

    i = rcv_sci(i);
    i = rcv_sci(i);
    i = rcv_sci(i);
    i = rcv_sci(i);

    while(1);
}

/*****
/* Function   : init_sci
/* Operation  : Initialize SCI0
/* Asynchronous Receive Mode
/*   -data length : 8bit
/*   -stop bit    : 1bit
/*   -parity bit  : Non-parity bit
/*****
void init_sci(void)
{
    unsigned long i;

    T_count = 0;
    Rd_count = 0;

    P_STBY.MSTCR1.BIT.MSTP16 = 0;          /* Disable SCI0 standby mode          */
    P_STBY.MSTCR2.BIT.MSTP12 = 0;          /* Disable CMT standby mode           */

    P_CMT.CMCSR_0.WORD = 0x0041;          /* Initialize CMCSR_0                 */
        // [15-8] = 0
        // [7]CMF = 0
        // [6]CMIE = 1    CMT0 interrupt enable
        // [5-2] = 0
        // [1]CKS1 = 0
        // [0]CKS0 = 1    count clock = P phi/32
    P_CMT.CMCOR_0 = 0x0F42;                /* Set CMCOR_0 (5msec)                */
    P_CMT.CMCNT_0 = 0;                     /* Initialize CMCNT_0                  */
    P_INTC.IPRG.BIT.CMT0 = 0xF;           /* Set CMT0 interrupt level           */
    set_imask(0);                          /* Clear interrupt mask level         */
}

```

```

/* Initialize SCI asynchronous mode */
P_SCI0.SCR_0.BYTE &= 0x03 ;          /* Clear TIE,RIE,TE,RE,MPIE,TEIE bit */
P_SCI0.SCR_0.BIT.CKE = 0;           /* Clock:internal,SCK:output */
P_SCI0.SMR_0.BYTE = 0x00;           /* 8bit,No parity,1stop bit */
    // CA      = 0;                  /* Asynchronous mode */
    // CHR      = 0;                  /* Data length 8 bits */
    // PE      = 0;                  /* Non-parity */
    // OE      = 0;                  /* (=0)even parity */
    // STOP    = 0;                  /* 1 stop bit */
    // CKS     = 0;                  /* Clock source = P phi(25MHz) */
P_SCI0.BRR_0 = 40;                   /* 19200bps@25MHz */
P_SCI0.SDCR_0.BIT.DIR = 0;          /* LSB first */

for( i=0; i < 0x0400 ; i++);        /* Wait 1 bit */

/* Initialize SCIO PORT */
P_PORTA.PACRL2.BIT.PA0MD = 1;       /* Set RXD0(PA1:130pin@SH7145) */

P_SCI0.SCR_0.BIT.RE = 1;            /* RE=1,receive enable */
}

/*****
/* Function      : rcv_sci
/* Operation    : Receive serial data(SCIO)
/* Asynchronous Receive Mode
*****/
unsigned char rcv_sci(unsigned char rev_count )
{
    while(P_SCI0.SSR_0.BIT.RDRF == 0){ /* Wait until RDRF flag high level */
        err();                          /* Error judging */

        /* Judging break detect
        if(P_SCI0.SCR_0.BIT.RE == 0)    /* Break detect */
            break;
        }

    Rev_data[rev_count] = P_SCI0.RDR_0; /* Store receive data */

    P_SCI0.SSR_0.BIT.RDRF = 0;         /* Clear RDRF flag */

    rev_count++ ;                      /* Storing address increment */

    return(rev_count);
}

```

```

/*****
/* Function      : err
/* Operation    : error judging(SCIO)
/* Asynchronous Receive Mode
/*****
void err(void)
{
    if(P_SCI0.SSR_0.BIT.ORER == 1){
        P_SCI0.SSR_0.BIT.ORER = 0;
    }

    if(P_SCI0.SSR_0.BIT.FER == 1){
        if(P_PORTA.PADRL.BIT.PA0DR == 0){
            P_CMT.CMSTR.BIT.STR = 1;
            while(T_count != 0);
            if(Rd_count == 3){
                P_SCI0.SCR_0.BIT.RE = 0;
            }
        }

        P_SCI0.SSR_0.BIT.FER = 0;
    }

    if(P_SCI0.SSR_0.BIT.PER == 1){
        P_SCI0.SSR_0.BIT.PER = 0;
    }
}
/*****
/* Interruption Program
/*****
/*****
/* CMT0 Interruption Program
/*****
#pragma interrupt(cmt_int)
void cmt_int(void)
{
    P_CMT.CMCSR_0.BIT.CMF = 0;

    /* Read RxD-pin level
    if(P_PORTA.PADRL.BIT.PA0DR == 0){
        Rd_count++;
    }

    T_count--;

    /* Judging interrupt times
    if(T_count == 0){
        P_CMT.CMSTR.BIT.STR = 0;
    }
}
/*****
/* Other Interruption Program
/*****
#pragma interrupt(dummy_f)
void dummy_f(void)
{
    /* Other Interrupt */
}

```

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Sep.16.04	—	First edition issued

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